

SPECIFICATIONS (T _J = 25 °C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Condition		Min	Typ	Max	Unit
Static							
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	N-Ch	0.6		1.6	V
		V _{DS} = V _{GS} , I _D = −250 μA	P-Ch	−0.8		−2.2	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA	N-Ch		40		mV/°C
			P-Ch		−40		
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J		N-Ch		−3.8		
			P-Ch		3.4		
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 12 V	N-Ch			± 100	nA
		V _{DS} = 0 V, V _{GS} = ± 16 V	P-Ch			± 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	N-Ch			1	μA
		V _{DS} = −40 V, V _{GS} = 0 V	P-Ch			−1	
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 55 °C	N-Ch			10	
		V _{DS} = −40 V, V _{GS} = 0 V, T _J = 55 °C	P-Ch			−10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	N-Ch	20			A
		V _{DS} ≤ −5 V, V _{GS} = −10 V	P-Ch	−20			
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 5.2 A	N-Ch		0.033	0.040	Ω
		V _{GS} = −10 V, I _D = −4.5 A	P-Ch		0.045	0.054	
		V _{GS} = 4.5 V, I _D = 4.9 A	N-Ch		0.037	0.045	
		V _{GS} = −4.5 V, I _D = −3.9 A	P-Ch		0.059	0.072	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 5.2 A	N-Ch		18		S
		V _{DS} = −15 V, I _D = −4.5 A	P-Ch		13		
Diode Forward Voltage ^a	V _{SD}	I _S = 1.7 A, V _{GS} = 0 V	N-Ch		0.75	1.2	V
		I _S = −1.7 A, V _{GS} = 0 V	P-Ch		−0.79	−1.2	
Dynamic ^b							
Input Capacitance	C _{iss}	N-Channel V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz	N-Ch		700		pF
			P-Ch		805		
Output Capacitance	C _{oss}	P-Channel V _{DS} = −20 V, V _{GS} = 0 V, f = 1 MHz	N-Ch		76		
			P-Ch		120		
Reverse Transfer Capacitance	C _{rss}		N-Ch		45		
			P-Ch		85		
Total Gate Charge	Q _g	N-Channel V _{DS} = 20 V, V _{GS} = 4.5 V, I _D = 5.2 A	N-Ch		8	12	nC
			P-Ch		9	14	
Gate-Source Charge	Q _{gs}	P-Channel V _{DS} = −20 V, V _{GS} = −4.5 V, I _D = −4.5 A	N-Ch		1.5		
			P-Ch		2		
Gate-Drain Charge	Q _{gd}		N-Ch		2.4		
			P-Ch		3.6		
Gate Resistance	R _g		N-Ch		1.9	2.9	Ω
			P-Ch		11.5	18	
Turn-On Delay Time	t _{d(on)}	N-Channel V _{DD} = 15 V, R _L = 15 Ω I _D ≅ 1 A, V _{GEN} = 10 V, R _g = 6 Ω	N-Ch		7	11	ns
			P-Ch		8	13	
Rise Time	t _r	P-Channel V _{DD} = −15 V, R _L = 15 Ω I _D ≅ −1 A, V _{GEN} = −10 V, R _g = 6 Ω	N-Ch		11	17	
			P-Ch		12	18	
Turn-Off Delay Time	t _{d(off)}		N-Ch		27	40	
			P-Ch		74	110	
Fall Time	t _f		N-Ch		8	13	
			P-Ch		38	60	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 1.7 A, di/dt = 100 A/μs	N-Ch		25	40	ns
		I _F = −1.7 A, di/dt = 100 A/μs	P-Ch		27	45	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 1.7 A, di/dt = 100 A/μs	N-Ch		17	26	nC
		I _F = −1.7 A, di/dt = 100 A/μs	P-Ch		17	26	

Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.
- b. Guaranteed by design, not subject to production testing.

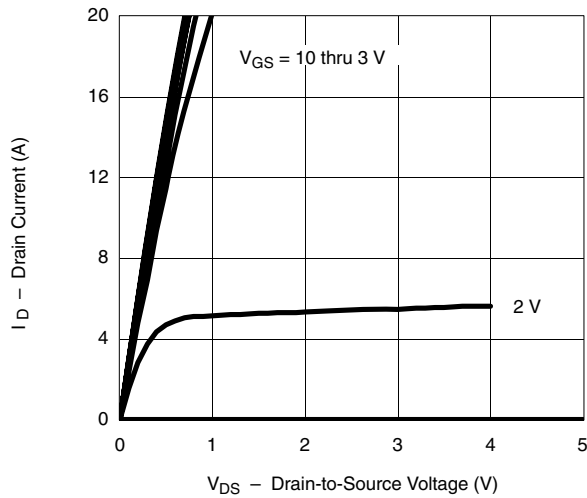
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



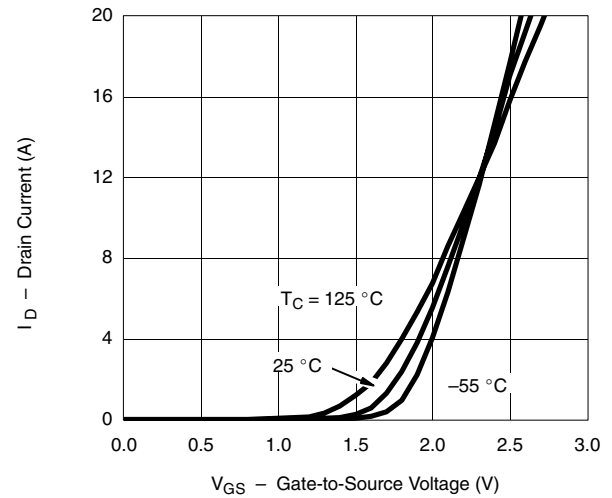
TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)

N-CHANNEL

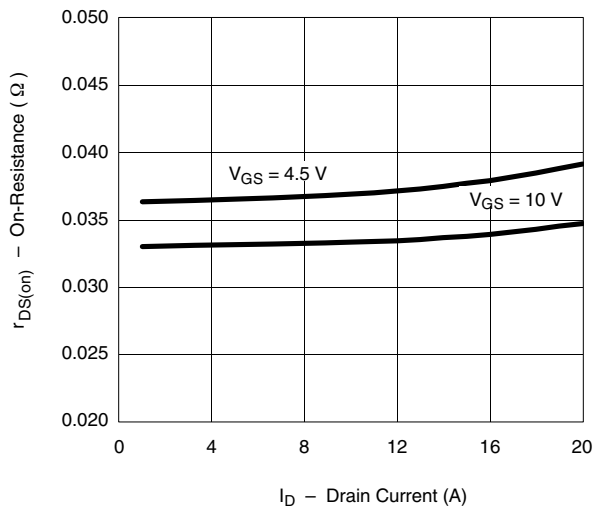
Output Characteristics



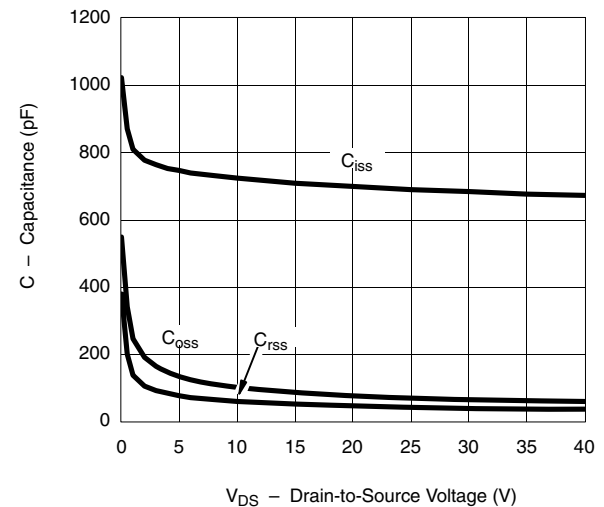
Transfer Characteristics



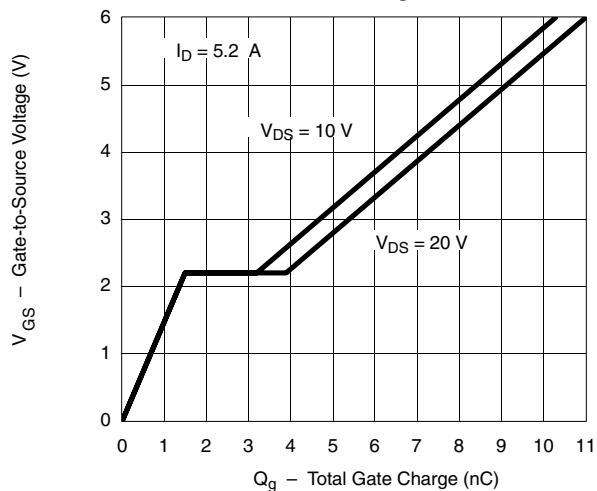
On-Resistance vs. Drain Current



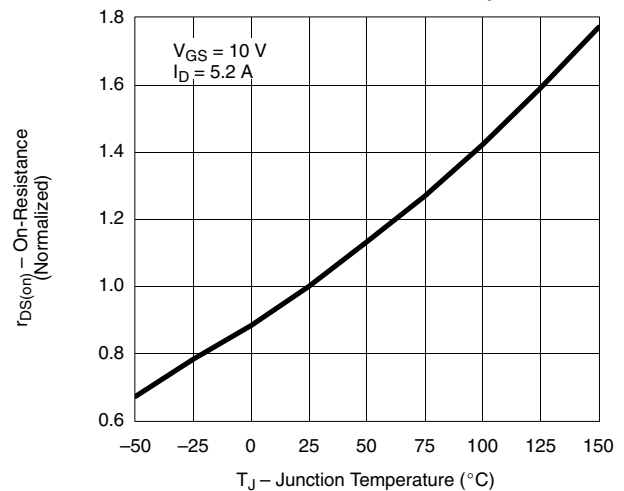
Capacitance



Gate Charge



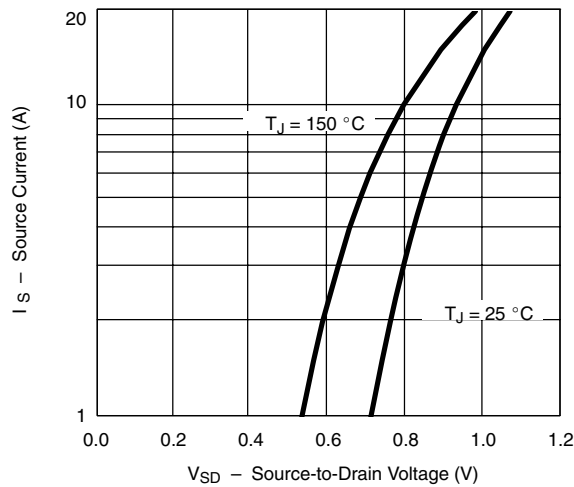
On-Resistance vs. Junction Temperature



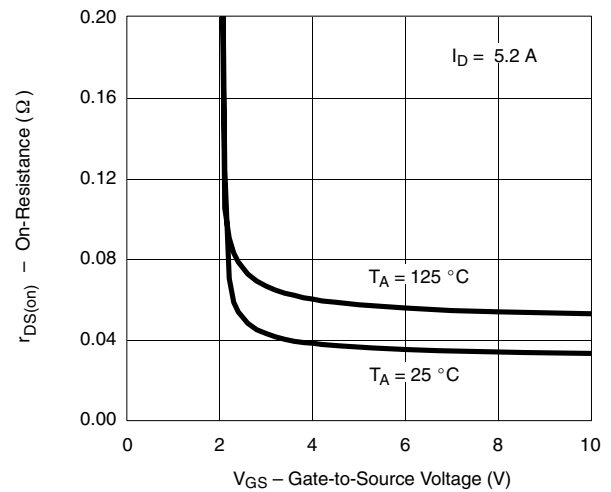
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N-CHANNEL

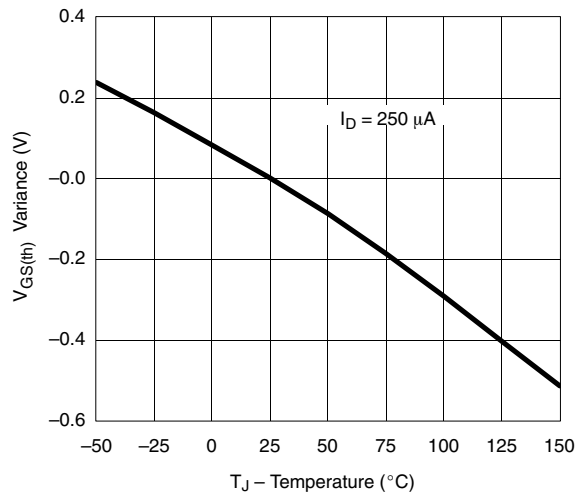
Source-Drain Diode Forward Voltage



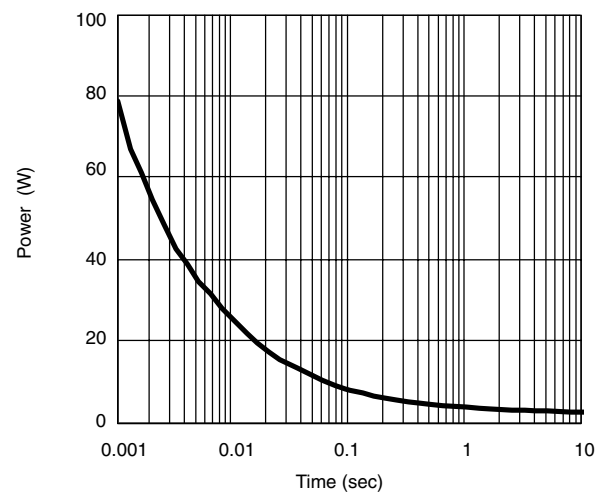
On-Resistance vs. Gate-to-Source Voltage



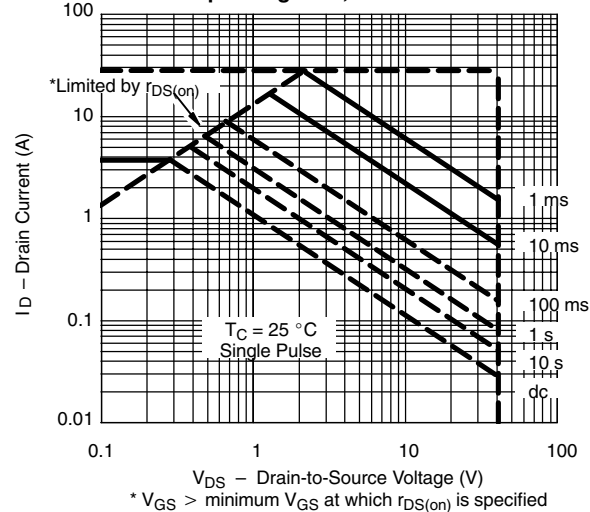
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



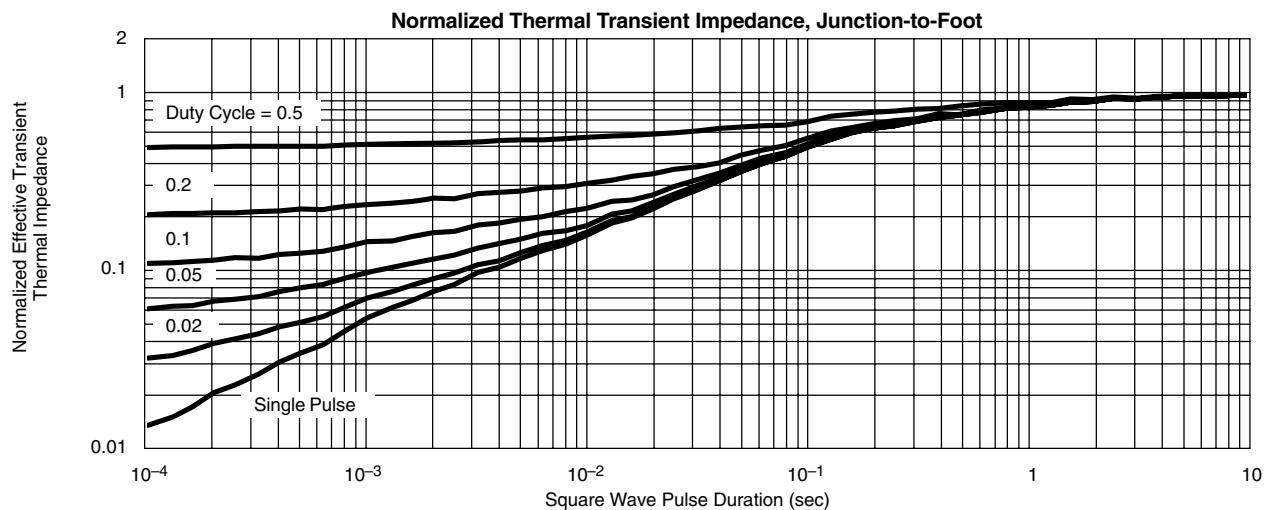
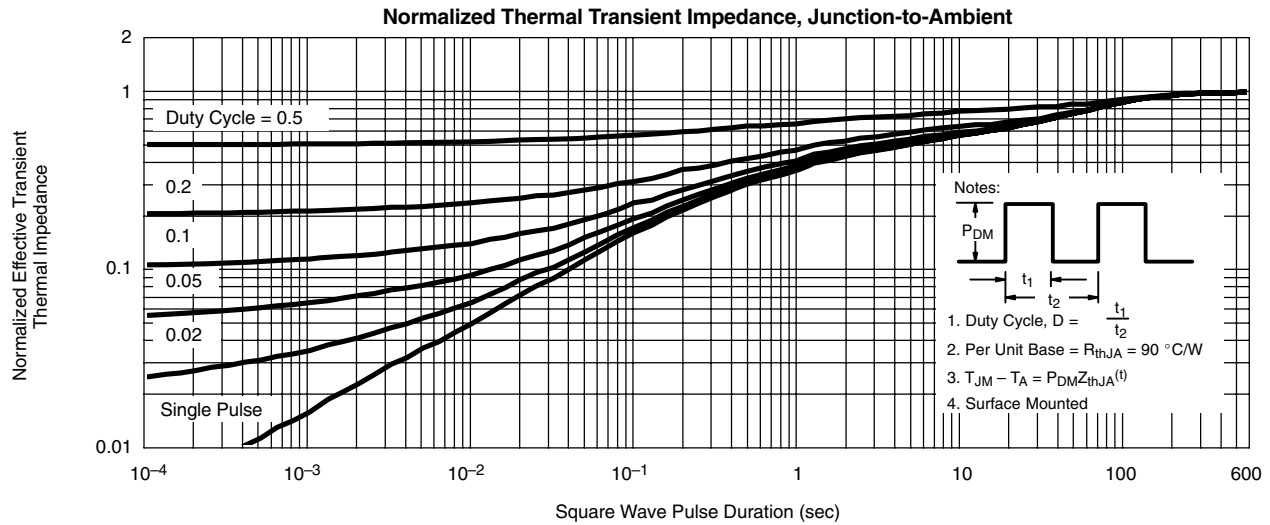
Safe Operating Area, Junction-to-Foot





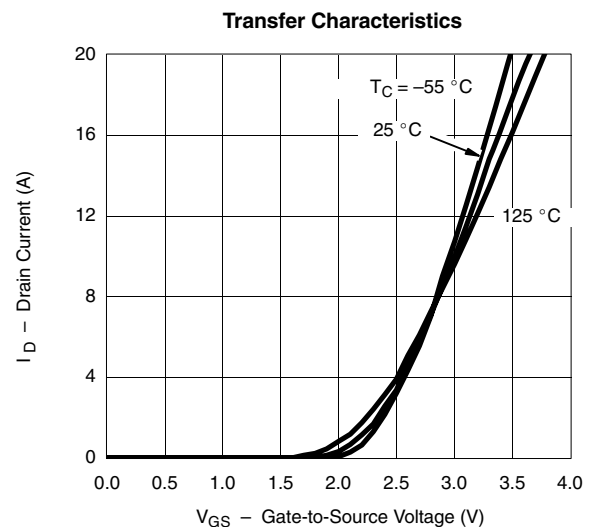
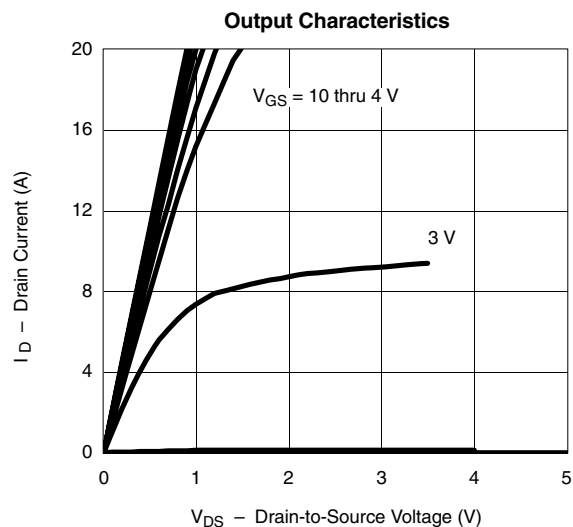
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N-CHANNEL



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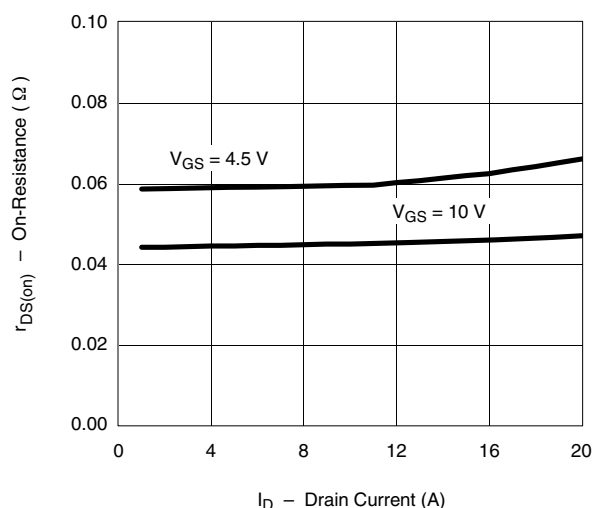
P-CHANNEL



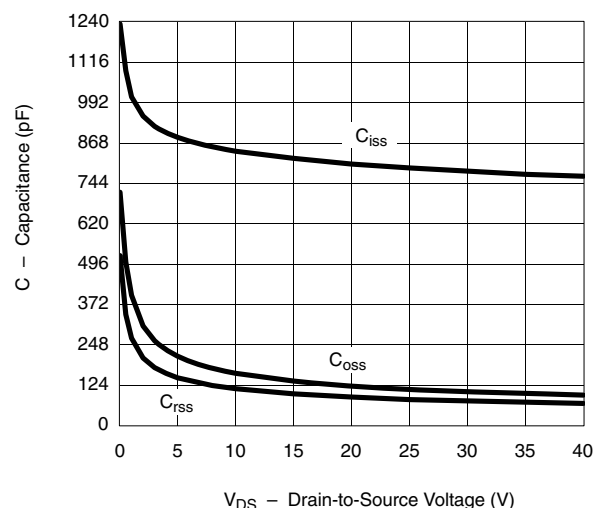
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P-CHANNEL

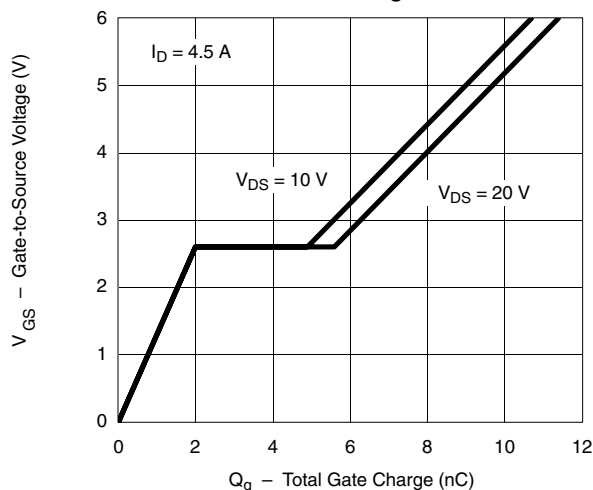
On-Resistance vs. Drain Current



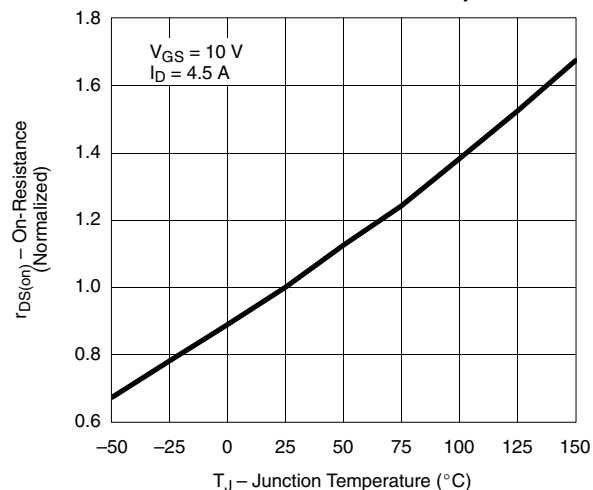
Capacitance



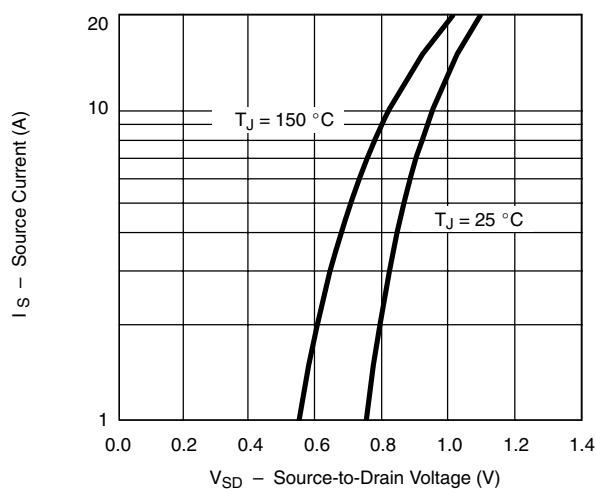
Gate Charge



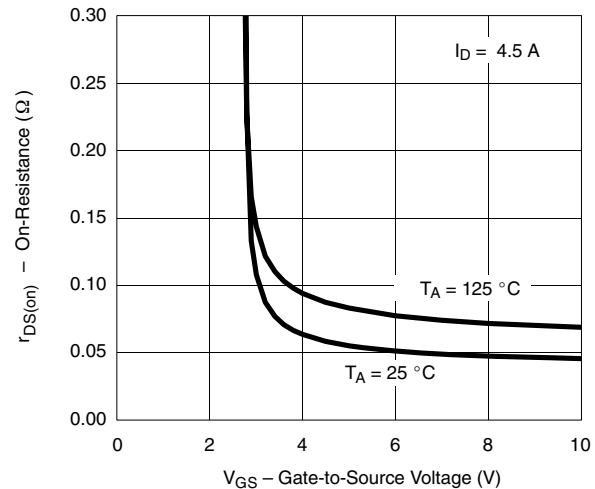
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



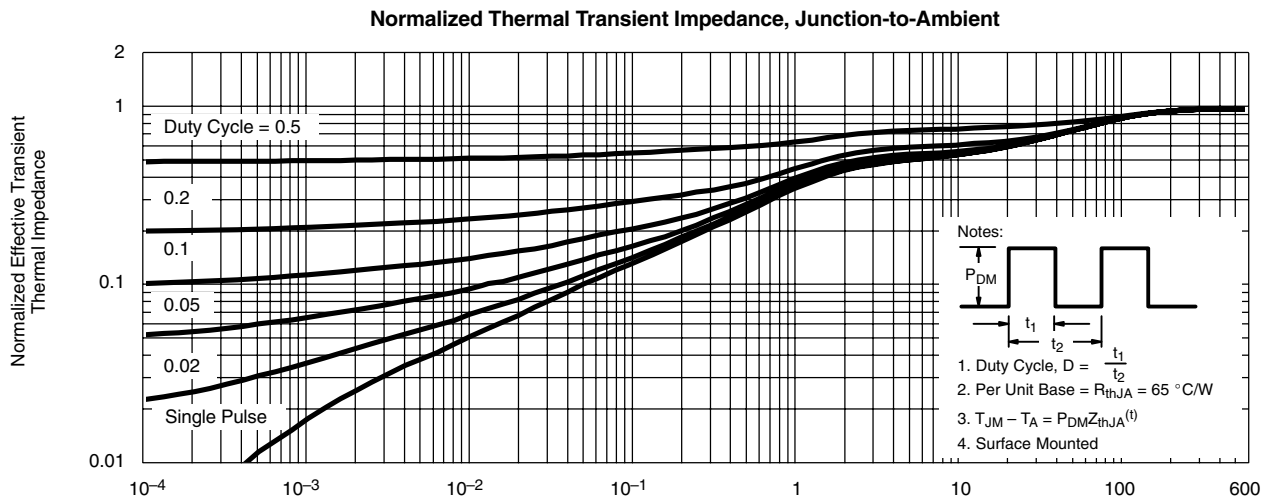
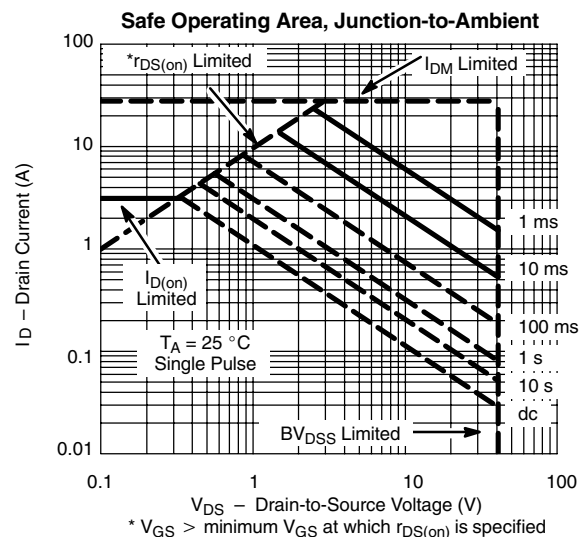
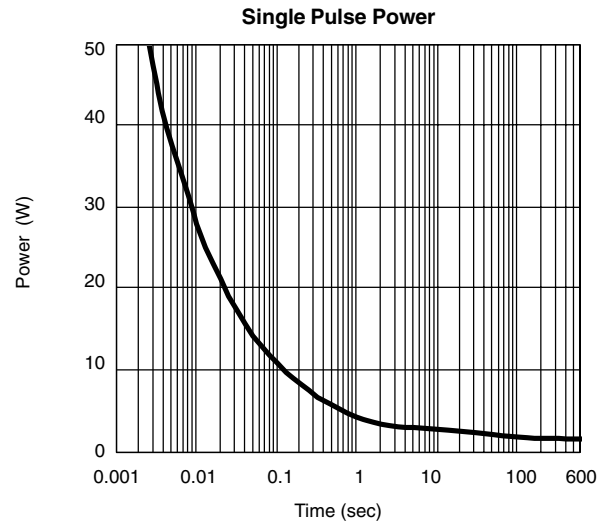
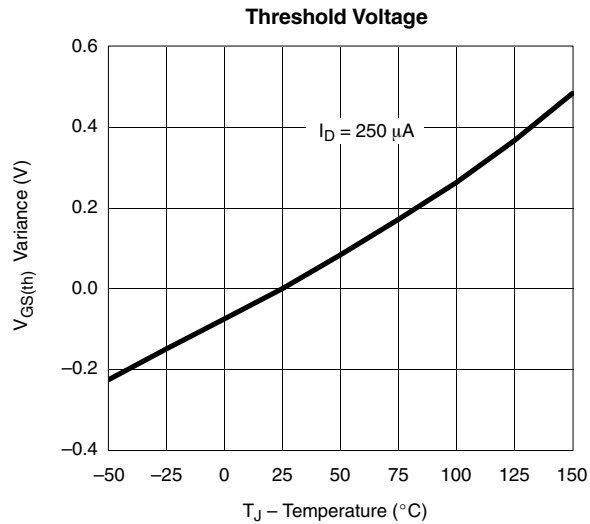
On-Resistance vs. Gate-to-Source Voltage

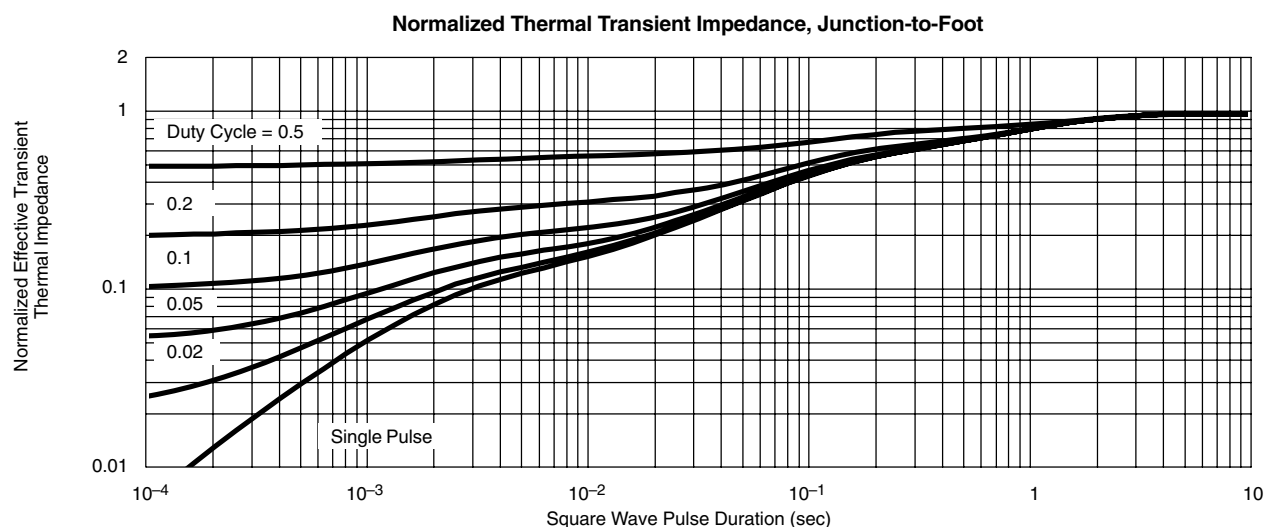




TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)

P-CHANNEL



TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)**P-CHANNEL**

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